

 ${\small \textbf{6}\textbf{mmL Chip Type}}, \ \ \textbf{Wide Temperature Range}$



- Chip type with load life 2000 hours at +105°C.
- Designed for surface mounting on high density PC board.
- Applicable to automatic mounting machine using carrier tape.
- Adapted to the RoHS directive (2002/95/EC).

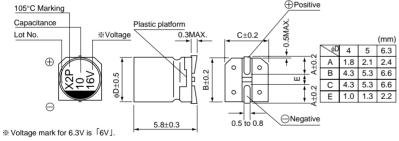




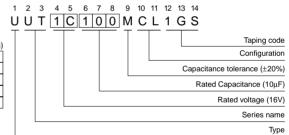
■Specifications

Item	Performance Characteristics												
Category Temperature Range	-55 to +105°C												
Rated Voltage Range	4 to 50V												
Rated Capacitance Range	0.1 to 100μF												
Capacitance Tolerance	±20% at 120Hz, 20°C												
Leakage Current	After 2 minutes' application of rated voltage, leakage current is not more than 0.01 CV or 3 (µA) , whichever is greater.												
	Measurement frequency :120Hz, Temperature : 20°C												
Tangent of loss angle (tan δ)	Rated voltage (V)	4	6.3		10	16	25	- ;	35	50			
0 0 0	tan δ (MAX.)	0.37	0.28	3 0).24	0.20	0.16	6 0	.13	0.12			
	Measurement frequency :120Hz												
	Rated voltage (V)			4	6.3	10	16	25	35	50			
Stability at Low Temperature	Impedance ratio	Z-25°C / Z	Z+20°C	6	3	3	2	2	2	2			
	ZT / Z20 (MAX.)	Z-40°C / Z	Z+20°C	12	8	5	4	3	3	3			
	The specifications listed at right shall be met Capacitance								Within ±25% of initial value (16V or less)				
F. 1	when the capacitors are restored to 20°C after the rated voltage is applied for 2000 hours at					ge	Wi	Within ±20% of initial value (25V or more)					
Endurance							200	200% or less of initial specified value					
	105°C. Leakage current Less than or equal to the initial specified value								ified value				
Shelf Life	After storing the capacitors under no load at 105°C for 1000 hours, and after performing voltage treatment based on JIS C 5101-4												
Sileli Lile	clause 4.1 at 20°C, they will meet the specified value for endurance characteristics listed above.												
Resistance to soldering	The capacitors shall be kept on the hot plate maintained at 250°C for 30 seconds. After removing from the hot plate, the capacitors meet the characteristic requirements listed at right when they are restored to 20°C.							Capacitance change		Within	Within ±10% of initial value		
								tan δ			Less than or equal to the initial specified value		
heat								Leakage current Less t			an or equal to the initial specified value		
Marking	Black print on the ca	ase top.											

■Chip Type



Type numbering system (Example: 16V 10µF)



■ Dimensions

	V	4	ļ	6.	3	10	0	1	6	2	5	3	5	50)
Cap.(µF)	Code	00	G	0,	J	1/	A	10	С	1	E	1'	V	1⊢	1
0.1	0R1				!		!		!		!		!	4	1.0
0.22	R22				i		İ		i		İ		i	4	2.6
0.33	R33		!		!		!				!		!	4	3.2
0.47	R47				i		İ							4	3.8
1	010		1		1				-					4	6.2
2.2	2R2												1	4	11
3.3	3R3		İ		İ		i		İ		į		İ	4	14
4.7	4R7						-			4	13	4	15	5	19
10	100				i		İ	4	18	5	23	5	25	6.3	30
22	220	4	22	4	22	5	27	5	30	6.3	38	6.3	42		
33	330	5	30	5	30	5	35	6.3	40	6.3	48				
47	470	5	36	5	36	6.3	46	6.3	50		!		!		Rated
100	101	6.3	60	6.3	60	6.3	60							Case size	ripple

Rated Ripple (mArms) at 105°C 120Hz

Frequency coefficient of rated ripple current

Frequency	50 Hz	120 Hz	300 Hz	1 kHz	10 kHz or more
Coefficient	0.70	1.00	1.17	1.36	1.50

- Taping specifications are given in page 23.
- Recommended land size, soldering by reflow are given in page 18, 19.
- Please select UX(p.90), UJ(p.92) series if high C/V products are required.
- Please refer to page 3 for the minimum order quantity.